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Messrs. Digi-Key

Issue No. :	PC-02-051
Date of issue:	November 15, 2002
Classification:	■ New □ Change □ Renewal

Delivery Specification

Product Description	: Directional Coupler
Product Part Number	: EHFFD1548
Classification of Spec	: Individual Product Specification
Applications	: Cellular phone
	For other applications, contact the undersigned in advance.
Term of Validity	: November 14, 2007 from the date of issue.

CUSTOMER USE ONLY	Receipt Record#:
This was certainly received by us. 1(one) copy is being returned to you.	Date of receipt:
r(one) copy to being retarried to you.	Received by:
	Title: Dept.:

Matsushita Electronic Components Co., Ltd. Network Device Company Module Strategic Business Unit Engineering Group HFD Team

992-1 Aiba Ohno-cho Ibi-gun Gifu 501-0598 JAPAN

Tel: +81-0585-36-2322 Fax: +81-0585-36-2344 Prepared by : S.Endo Checked by : M. Mizuno

Authorized by : M. Mizuno

Title : Manager of Engineering

[Shape, appearance, dimension] Unit: mm <Top view> <Bottom and side view> 1.6+/-0.2 Pin No. OUT (4) IN (3) (2) (1) Add'l R (1) (2) D OUT $0.6\pm {0.20\atop 0.05}$ Sn-Pb (Sn:Pb=9:1) or Sn Ni Ceramic substrate Ag-Pd

Note 1) "typ" is used where no dimensional tolerance applies.

Item	Description
Appearance/ construction	Product surface shall be covered with a protective film, which does not easily separate nor present noticeable unevenness, scratches, pinholes, color changes etc.
	Terminals shall ensure practically acceptable quality.
	Substrate shall be as shown in the drawing with no excessive chippings, scratches, burrs, or cracks.
Marking	Shall be legible in white (with printing paste).
Remarks	marked side for pin 1.

Directional Coupler		Delivery S	Specifica	tion	EHFFD1548			
Enact. Date November 15, 2002	P.S.M	Approval	Check	Plan	Appearance			
Enfo. Date November 15, 2002		M. Mizuno	M. Mizuno	S.Endo	Drawing No. 151-EHF-FD1548 9-1			

[Absolute maximum ratings]

No.	Item	Symbol	Rating	Unit	Remarks
1	Maximum input power	Pmax	3	V	DC voltage is 0V.
2	Operating temperature	Topr	-30+85	degC	
3	Storage temperature	Tstg	-40+85	degC	

Note: This component cannot apply a DC Bias.

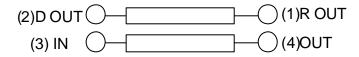
[Electrical characteristics]

T = +25 + / - 5 degC

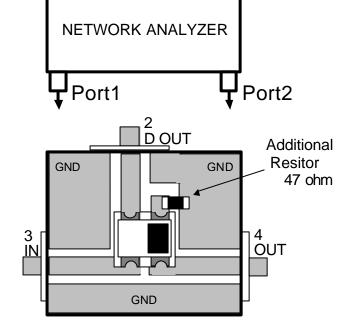
No.	Item	Test		Unit		
		Circuit	Min.	Тур.	Max.	
1	Frequency	-	1850	1900	1950	MHz
2	Insertion loss 2-1	Fig-1	-	-	*0.3	dB
3	Coupling 2-3	Fig-1	16	17	18	dB
4	Isolation 1-3	Fig-1	23	-	-	dB
5	Input VSWR	Fig-1	-	-	1.3	-

^{*} Value of insertion loss is not included the Test Board Loss(0.2dB)

[Internal circuitry]



[Measuring circuit]



- < Insertion loss & VSWR measurement >
- (3)IN=Port1, (4)OUT=Port2 (2)Detect OUT is connected 50 ohm.
- < Coupling measurement > (3)IN=Port1, (2)Detect OUT=Port2 (4)OUT is connected 50 ohm.
- < Isolation measurement > (4)OUT=Port1, (2)Detect OUT=Port2 (3)IN is connected 50 ohm.

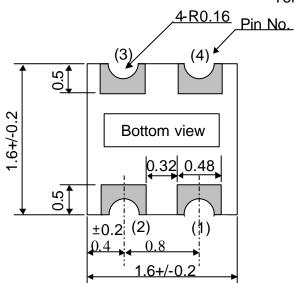
Directional Coupler	D	elivery S	pecificat	ion	EHF FD1548			
Enact. Date November 15, 2002	P.S.M	Approval	Check	Plan	Specification and measurement			
Enfo. Date November 15, 2002		M. Mizuno	M. Mizuno	S.Endo	Drawing No. 151-EHF- FD1548 9-2			

[Terminal dimensions] Unit: mm

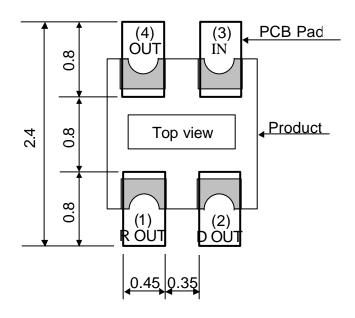
<Bottom>

Tolerance of

Terminal dimensions: +/-0.16



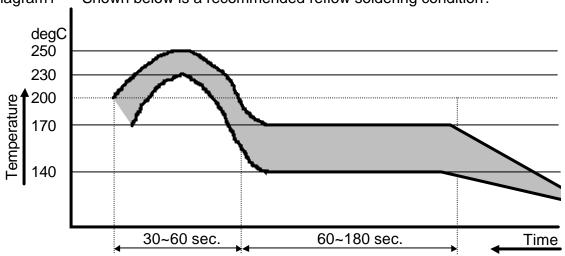
[Recommended PCB pad dimensions] Unit: mm



Directional Coupler Delivery Specification						EHF FD1548
Enact. Date November 15, 2002	P.S.M	Approval	Check	Plan		Terminals/Recommended lands
Enfo. Date November 15, 2002		M. Mizuno	M. Mizuno	S.Endo		Drawing No. 151-EHF- FD1548 9-3

[Quality characteristic	s]					
Test item	Test condition	Judgment criteria				
High temperature	+85degC, 1000h	No abnormality shall be observed in				
Low temperature	-40degC, 1000 h	appearance or				
High-temperature high-humidity storage	+60degC, 90%RH, 1000h	electrical characteristics.				
Pressure Pot	+121degC, 99%RH, 2.026x10 ⁵ Pa, 100h	Characteristics.				
Temperature cycling	-40+85degC, Each 30 min., 200cy					
Vibration	10500Hz, 10G, in each direction of XYZ, 2h30min.					
Impact	100G, 6mS, Half sinusoidal wave, in each direction of XYZ, 3 times					
Shock (Drop)	1.8m, 6 facesx6cy(36 times with 100g Dummy Load)					
Electro static discharge	200pF, 0 ohm, +/-200V, Each 5 times					
Soldering heat resistance	Manual hot gas: 260+/-10degC, 30 sec., 2 times	Over 90% of the terminal surface shall be covered				
	Soldering iron: 260+/-10degC, 3 sec., 2 times	with solder.				
	Reflow: 260degC peak, 2 times					
Solder ability	Solder bath: 235+/-5degC, 2 sec.	Over 95% of the terminal surface shall be covered				
	Reflow: 230degC	with solder.				
Board warping	Assemble this component on a PC board with 0.8mm thickness using the recommended soldering condition shown below, and apply a bending force of 3mm warping at a rate of 1mm/sec. 5 seconds and 5 times.	There should not be any cracks in the component or solder joints, no abnormality in electrical characteristics.				
Terminal removal Solder a component on a PC board using the recommended condition shown below and then press the component sideways at 1mm/sec. Destruction limit 9.8N or greater.						
Seating plane co-planarity	Within 0.1mm					





Directional Coupler	D	elivery S	pecificat	EHF FD1548	
Enact. Date November 15, 2002	P.S.M	Approval	Check	Plan	Quality Characteristics
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[Cautions for use]

- (1) Operating a product over the maximum rating for even a moment may result in a product failure or breakage. Never use a product in such a condition that it may cause a safety problem.
- (2) Opening or short-circuiting the product terminals or inserting a product in the reverse orientation while power is being supplied may cause a breakage. Always avoid such circumstances.
- (3) Operations in a corrosive gas atmosphere or improper environments such as high-temperature, high-humidity or dewy conditions may lead to product performance deterioration, a breakage, a change in appearance etc. Please avoid such conditions, as they are unsafe.
- (4) Always ground the soldering iron or soldering bath used for assembly operation to avoid any excessive voltage applied to a product.
- (5) After soldering with solder bridges, incomplete soldering or in the reverse orientation, supplying power may result in a product breakage. Please confirm the soldered condition before supplying power to the product.
- (6) Excessive stress on the terminals may cause a contact failure or performance deterioration. Please use caution.
- (7) Please provide a fail-safe provision in the product you design by taking any failure of our product into consideration.
- (8) This product does not include a DC-cutting device. Application of a DC Current may cause product deterioration or breakage.
 - * If any question arises about the safety of this product, please contact us immediately with a request for an engineering examination.

[Remarks]

- *1: All of the materials used in this product are those listed as the existing chemical substances based on the "Law for examination and regulation of manufacture of chemical substances".
- *2: The production process of this product does not use any ozone-depleting chemicals (OZC) regulated by the Montreal Protocol.
- *3: Validity of this specification is 5 years from the date of issue, but the validity is considered on going unless any changes are made.

Directional Coupler Delivery Specification						EHF FD1548
Enact. Date November 15, 2002	P.S.M	Approval	Check	Plan		Cautions
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[Packaging materials] 1. Materials 1)

- 1) Embossed carrier tape (Refer to the attachment)
 2) Top tape: Anti-static

- 3) Packaging box (Refer to the attachment)4) Packaging tape, carrier-securing adhesive tape

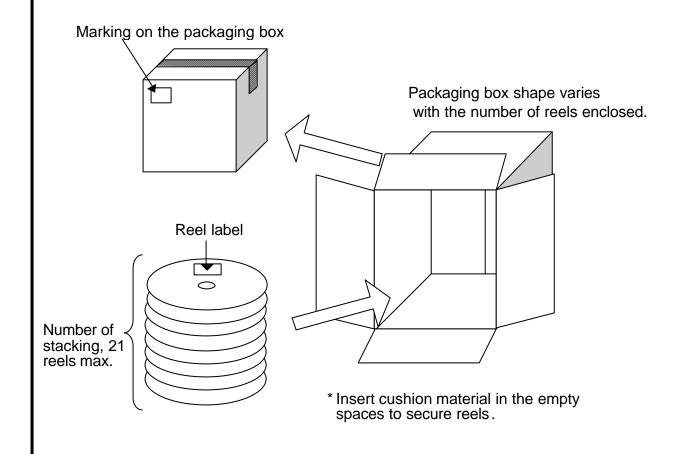
2. Specification

No.	Item	Condition	Remarks
1	Reel outer diameter	Refer to the attachment.	
2	Reel inner diameter	Refer to the attachment.	
3		Refer to the attachment.	
4	Quantity in a reel	4000 pieces/reel	
5	Taping direction	Tape unreeling direction (with markings facing up)	
6	Top tape attachment position	Top tape	Tape breaks force. Min. 10N Top cover tape strength. Min. 10N Tape peel force. 0.11.0N Tape peel angle. 165180degree Reel weight. Max 1500g
7	Label attachment position	Tape unreeling direction	Indicated Item Pat No., Lot No. Quantity, Maker Country
8	Tape leader part and tape ending part	Ending part Product-loaded part Embossed carrier Top tape 200~220mm (Product-unloaded part) 100~150mm, 25~38 pieces worth, (Product-unloaded part) 300~ 400mm	
9	•	No missing products shall be allowed. 21 reels/box (Max)	84000 pieces/box(Max)
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Directional Coupler Delivery Specification					EHF FD1548		
Enact. Date November 15, 2002	P.S.M	Approval	Check	Plan	Packaging specification 1		
Enfo. Date November 15, 2002		M. Mizuno	M. Mizuno	S.Endo	Drawing No. 151-EHF- FD1548 9-6		

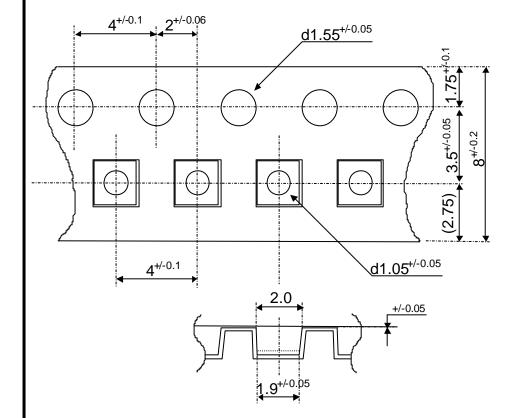
1. Method

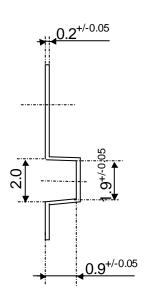
- 1) Load products in each cavity of an embossed carrier tape, in the correct orientation, by leaving the product-unloaded part shown in Item No. 8(P9-6) of the packaging specification.
- 2) Heat-seal a top tape in good alignment on the carrier tape.
- 3) After 4000 pieces are loaded and reeled, provide a product-unloaded part at the tape-leader portion. Secure the tip of the carrier tape with a piece of adhesive tape.
- 4) Stack the reels (21 reels max.) and enclose them in a packaging box. Close the flaps with a piece of adhesive tape.
- 5) Provide markings on the packaging box.
 - < Items to be indicated >
 - 1. Part No.
 - 2. Quantity
 - 3. Lot No.
 - 4. Manufacturer name
 - 5. Country of origin



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[Embossed tape reel dimensions] Unit: mm





<Remarks>

- (1) Unspecified corner radius shall be 0.3mm max.
- (2) Cumulative pitch error of sprocket holes shall be +/-0.2mm for 10 pitches.

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